## Features

- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free by Design/RoHS Compliant (Note 3)
- "Green" Device (Notes 4 and 5)


## SURFACE MOUNT SCHOTTKY BARRIER DIODE

Please click here to visit our online spice models database.

## Mechanical Data

- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Leads: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.004 grams (approximate)


Top View

Maximum Ratings $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage | $V_{R R M}$ <br> $V_{R W M}$ <br> $V_{R}$ | 30 | V |
| Working Peak Reverse Voltage |  |  |  |
| DC Blocking Voltage |  |  |  |

## Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Power Dissipation (Note 1) | $\mathrm{P}_{\mathrm{D}}$ | 150 | mW |
| Thermal Resistance, Junction to Ambient Air (Note 1) | $\mathrm{R}_{\theta J \mathrm{~A}}$ | 667 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {STG }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reverse Breakdown Voltage (Note 2) | $\mathrm{V}_{(\mathrm{BR}) \mathrm{R}}$ | 30 | - | - | V | $\mathrm{I}_{\mathrm{R}}=100 \mu \mathrm{~A}$ |
| Forward Voltage | $V_{\text {FM }}$ | - | - | $\begin{gathered} \hline 320 \\ 400 \\ 1000 \end{gathered}$ | mV | $\begin{aligned} & I_{F}=1 \mathrm{~mA} \\ & I_{F}=10 \mathrm{~mA} \\ & I_{F}=100 \mathrm{~mA} \end{aligned}$ |
| Reverse Leakage Current (Note 2) | $\mathrm{I}_{\mathrm{RM}}$ | - | - | 2.0 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{R}}=25 \mathrm{~V}$ |
| Reverse Recovery Time | $\mathrm{trr}^{\text {r }}$ | - | - | 5.0 | ns | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ through $\mathrm{I}_{\mathrm{R}}=10 \mathrm{~mA}$ <br> to $\mathrm{I}_{\mathrm{R}}=1.0 \mathrm{~mA}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |

Notes: 1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
2. Short duration pulse test used to minimize self-heating effect.
3. No purposefully added lead.
4. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
5. Product manufactured with date code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants


Fig. 1 Forward Characteristics


Fig. 3 Power Derating Curve


Fig. 2 Typical Reverse Characteristics

## Ordering Information (Note 6)

| Part Number | Case | Packaging |
| :--- | :---: | :---: |
| BAT54WT-7 (Note 7) | SOD-523 | 3000/Tape \& Reel |
| Notes: | 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. <br> 7. Dispensed in every other cavity of the tape. |  |
|  |  |  |
| Marking Information |  |  |



## Package Outline Dimensions



| SOD-523 |  |  |
| :---: | :---: | :---: |
| Dim | Min | Max |
| A | 0.25 | 0.35 |
| B | 0.70 | 0.90 |
| C | 1.50 | 1.70 |
| H | 1.10 | 1.30 |
| K | 0.55 | 0.65 |
| L | 0.10 | 0.30 |
| M | 0.10 | 0.12 |
| All Dimensions in $\mathbf{~ m m}$ |  |  |

## Suggested Pad Layout



| Dimensions | Value (in $\mathbf{~ m m}$ ) |
| :---: | :---: |
| $\mathbf{Z}$ | 2.3 |
| $\mathbf{G}$ | 1.1 |
| $\mathbf{X}$ | 0.8 |
| $\mathbf{Y}$ | 0.6 |
| $\mathbf{C}$ | 1.7 |

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